

### General Description

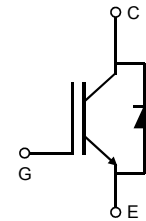
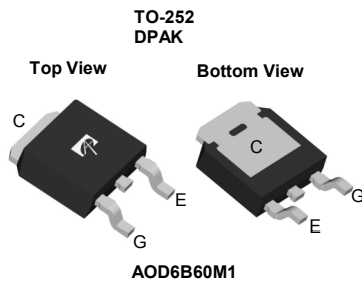
- Latest AlphaIGBT (αIGBT) Technology
- 600V Breakdown Voltage
- Very Fast and Soft Recovery Freewheeling Diode
- High Efficient Turn-On di/dt Controllability
- Low  $V_{CE(sat)}$  Enables High Efficiencies
- Low Turn-Off Switching Loss and Softness
- Very Good EMI Behavior
- High Short-Circuit Ruggedness
- Offering  $T_J(max)$  of 150C
- Minimal Gate Spike Due to High Input Capacitance

### Applications

- Home Appliances
- Motor Drives

### Product Summary

$V_{CE}$	600V
$I_C$ ( $T_C=100^\circ\text{C}$ )	6A
$V_{CE(sat)}$ ( $T_J=25^\circ\text{C}$ )	1.7V



Orderable Part Number	Package Type	Form	Minimum Order Quantity
AOD6B60M1	TO252	Tape & Reel	2500

### Absolute Maximum Ratings $T_A=25^\circ\text{C}$ unless otherwise noted

Parameter	Symbol	AOD6B60M1	Units
Collector-Emitter Voltage	$V_{CE}$	600	V
Gate-Emitter Voltage	$V_{GE}$	$\pm 30$	V
Continuous Collector Current	$I_C$	$T_C=25^\circ\text{C}$	12
		$T_C=100^\circ\text{C}$	6
Pulsed Collector Current, Limited by $T_{Jmax}$	$I_{CM}$	18	A
Turn off SOA, $V_{CE} \leq 650\text{V}$ , Limited by $T_{Jmax}$	$I_{LM}$	18	A
Continuous Diode Forward Current	$I_F$	$T_C=25^\circ\text{C}$	12
		$T_C=100^\circ\text{C}$	6
Diode Pulsed Current, Limited by $T_{Jmax}$	$I_{FM}$	18	A
Short circuit withstanding time <sup>1)</sup> $V_{GE}=15\text{V}$ , $V_{CC} \leq 400\text{V}$ , $T_J \leq 150^\circ\text{C}$	$t_{SC}$	5	$\mu\text{s}$
Power Dissipation	$P_D$	$T_C=25^\circ\text{C}$	69
		$T_C=100^\circ\text{C}$	28
Junction and Storage Temperature Range	$T_J, T_{STG}$	-55 to 150	$^\circ\text{C}$
Maximum lead temperature for soldering purpose, 1/8" from case for 5 seconds	$T_L$	300	$^\circ\text{C}$

### Thermal Characteristics

Parameter	Symbol	AOD6B60M1	Units
Maximum Junction-to-Ambient	$R_{\theta JA}$	55	$^\circ\text{C/W}$
Maximum IGBT Junction-to-Case	$R_{\theta JC}$	1.8	$^\circ\text{C/W}$
Maximum Diode Junction-to-Case	$R_{\theta JC}$	3	$^\circ\text{C/W}$

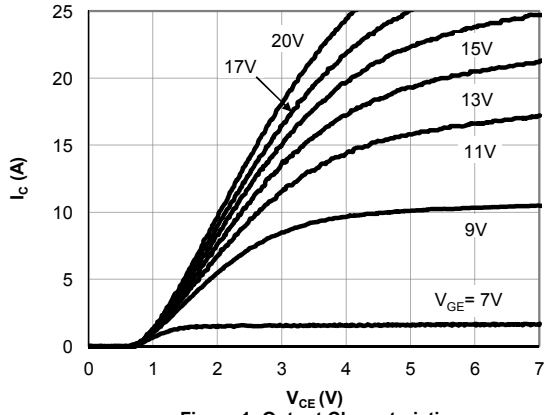
1) Allowed number of short circuits: <1000; time between short circuits: >1s.

**Electrical Characteristics (T<sub>J</sub>=25°C unless otherwise noted)**

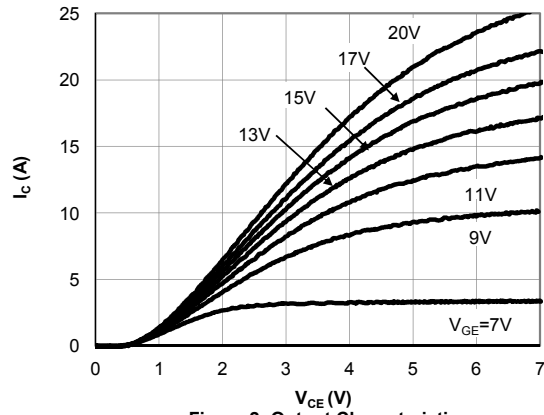
Symbol	Parameter	Conditions	Min	Typ	Max	Units	
<b>STATIC PARAMETERS</b>							
BV <sub>CES</sub>	Collector-Emitter Breakdown Voltage	I <sub>C</sub> =1mA, V <sub>GE</sub> =0V, T <sub>J</sub> =25°C	600	-	-	V	
V <sub>CE(sat)</sub>	Collector-Emitter Saturation Voltage	V <sub>GE</sub> =15V, I <sub>C</sub> =6A	T <sub>J</sub> =25°C	-	1.7	2.15	V
			T <sub>J</sub> =125°C	-	2	-	
			T <sub>J</sub> =150°C	-	2.1	-	
V <sub>F</sub>	Diode Forward Voltage	V <sub>GE</sub> =0V, I <sub>F</sub> =6A	T <sub>J</sub> =25°C	-	1.45	1.85	V
			T <sub>J</sub> =125°C	-	1.41	-	
			T <sub>J</sub> =150°C	-	1.37	-	
V <sub>GE(th)</sub>	Gate-Emitter Threshold Voltage	V <sub>CE</sub> =5V, I <sub>C</sub> =1mA	-	5.1	-	V	
I <sub>CES</sub>	Zero Gate Voltage Collector Current	V <sub>CE</sub> =600V, V <sub>GE</sub> =0V	T <sub>J</sub> =25°C	-	-	10	μA
			T <sub>J</sub> =125°C	-	-	500	
			T <sub>J</sub> =150°C	-	-	1000	
I <sub>GES</sub>	Gate-Emitter leakage current	V <sub>CE</sub> =0V, V <sub>GE</sub> =±30V	-	-	±100	nA	
g <sub>FS</sub>	Forward Transconductance	V <sub>CE</sub> =20V, I <sub>C</sub> =6A	-	5	-	S	
<b>DYNAMIC PARAMETERS</b>							
C <sub>ies</sub>	Input Capacitance	V <sub>GE</sub> =0V, V <sub>CC</sub> =25V, f=1MHz	-	345	-	pF	
C <sub>oes</sub>	Output Capacitance		-	36	-	pF	
C <sub>res</sub>	Reverse Transfer Capacitance		-	13	-	pF	
Q <sub>g</sub>	Total Gate Charge	V <sub>GE</sub> =15V, V <sub>CC</sub> =480V, I <sub>C</sub> =6A	-	14	-	nC	
Q <sub>ge</sub>	Gate to Emitter Charge		-	3.4	-	nC	
Q <sub>gc</sub>	Gate to Collector Charge		-	7.3	-	nC	
I <sub>C(SC)</sub>	Short circuit collector current	V <sub>GE</sub> =15V, V <sub>CC</sub> =400V, t <sub>sc</sub> ≤5us, T <sub>J</sub> ≤150°C	-	30	-	A	
R <sub>g</sub>	Gate resistance	V <sub>GE</sub> =0V, V <sub>CC</sub> =0V, f=1MHz	-	6.5	-	Ω	
<b>SWITCHING PARAMETERS, (Load Inductive, T<sub>J</sub>=25°C)</b>							
T <sub>d(on)</sub>	Turn-On Delay Time	T <sub>J</sub> =25°C V <sub>GE</sub> =15V, V <sub>CC</sub> =400V, I <sub>C</sub> =6A, R <sub>G</sub> =50Ω	-	7	-	ns	
T <sub>r</sub>	Turn-On Rise Time		-	13	-	ns	
T <sub>d(off)</sub>	Turn-Off Delay Time		-	94	-	ns	
T <sub>f</sub>	Turn-Off Fall Time		-	16	-	ns	
E <sub>on</sub>	Turn-On Energy		-	0.12	-	mJ	
E <sub>off</sub>	Turn-Off Energy		-	0.09	-	mJ	
E <sub>total</sub>	Total Switching Energy		-	0.21	-	mJ	
T <sub>rr</sub>	Diode Reverse Recovery Time	T <sub>J</sub> =25°C I <sub>F</sub> =6A, dI/dt=200A/μs, V <sub>CC</sub> =400V	-	74	-	ns	
Q <sub>rr</sub>	Diode Reverse Recovery Charge		-	0.15	-	μC	
I <sub>rm</sub>	Diode Peak Reverse Recovery Current		-	3.5	-	A	
<b>SWITCHING PARAMETERS, (Load Inductive, T<sub>J</sub>=150°C)</b>							
T <sub>d(on)</sub>	Turn-On Delay Time	T <sub>J</sub> =150°C V <sub>GE</sub> =15V, V <sub>CC</sub> =400V, I <sub>C</sub> =6A, R <sub>G</sub> =50Ω	-	6	-	ns	
T <sub>r</sub>	Turn-On Rise Time		-	14	-	ns	
T <sub>d(off)</sub>	Turn-Off Delay Time		-	114	-	ns	
T <sub>f</sub>	Turn-Off Fall Time		-	44	-	ns	
E <sub>on</sub>	Turn-On Energy		-	0.15	-	mJ	
E <sub>off</sub>	Turn-Off Energy		-	0.14	-	mJ	
E <sub>total</sub>	Total Switching Energy		-	0.29	-	mJ	
T <sub>rr</sub>	Diode Reverse Recovery Time	T <sub>J</sub> =150°C I <sub>F</sub> =6A, dI/dt=200A/μs, V <sub>CC</sub> =400V	-	181	-	ns	
Q <sub>rr</sub>	Diode Reverse Recovery Charge		-	0.37	-	μC	
I <sub>rm</sub>	Diode Peak Reverse Recovery Current		-	4.7	-	A	

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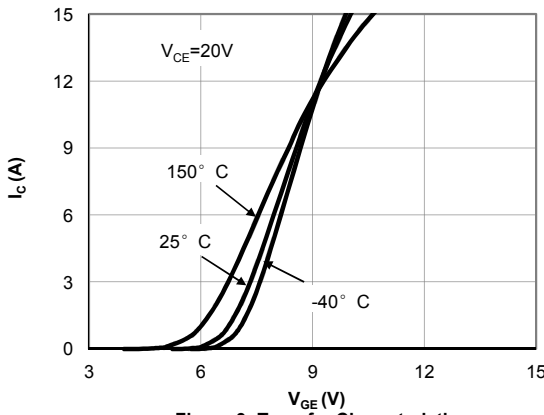
**TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS**



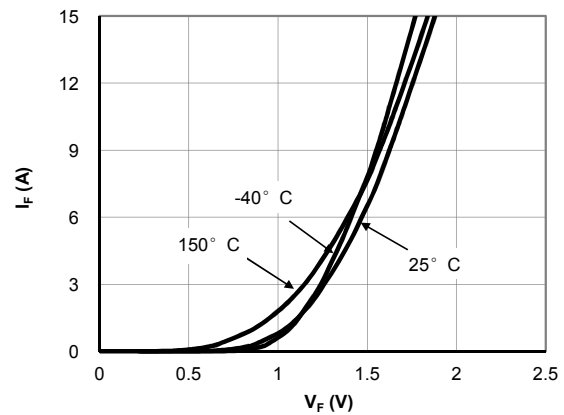
**Figure 1: Output Characteristic**  
( $T_j=25^\circ\text{C}$ )



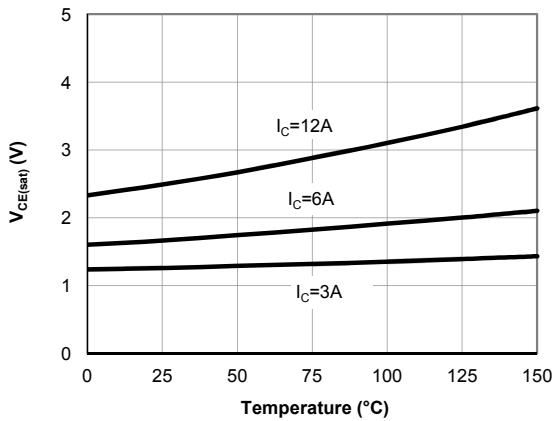
**Figure 2: Output Characteristic**  
( $T_j=150^\circ\text{C}$ )



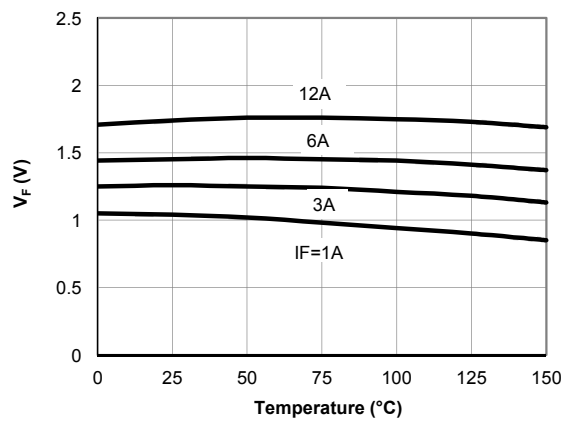
**Figure 3: Transfer Characteristic**



**Figure 4: Diode Characteristic**



**Figure 5: Collector-Emitter Saturation Voltage vs. Junction Temperature**



**Figure 6: Diode Forward voltage vs. Junction Temperature**

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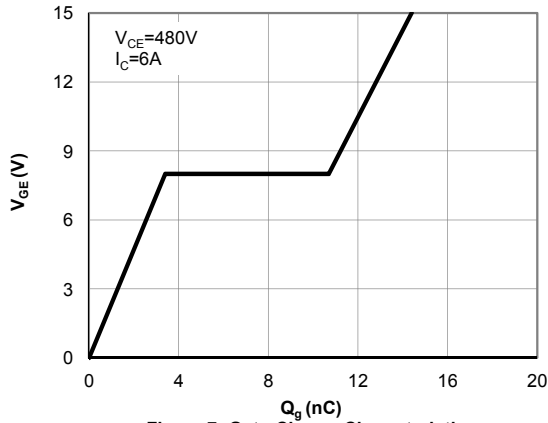


Figure 7: Gate-Charge Characteristics

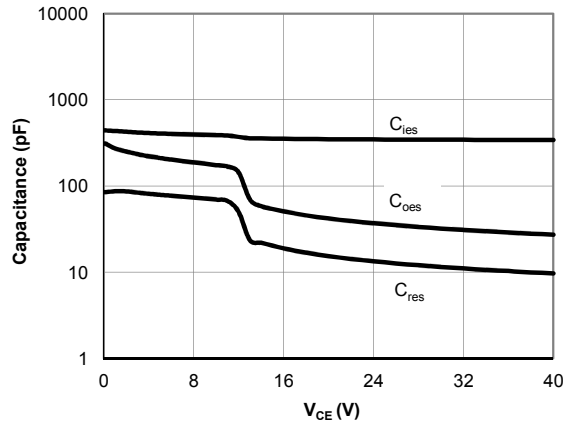


Figure 8: Capacitance Characteristic

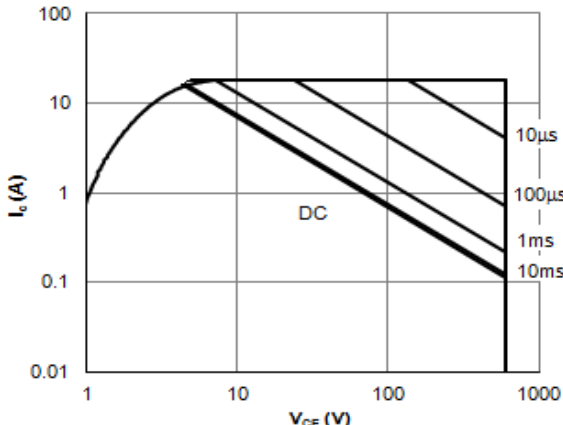


Figure 9: Forward Bias Safe Operating Area  
( $T_C=25^\circ\text{C}$ ,  $V_{GE}=15\text{V}$ )

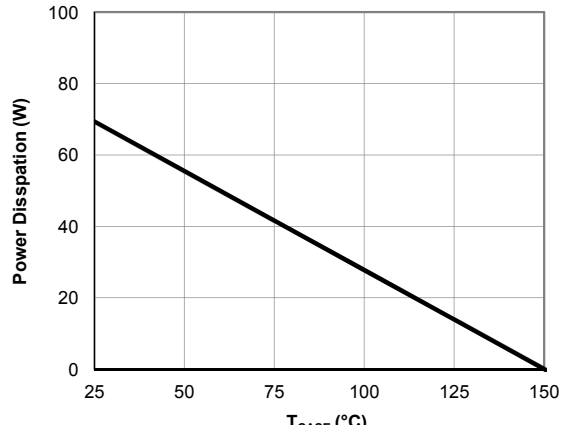


Figure 10: Power Dissipation as a Function of Case

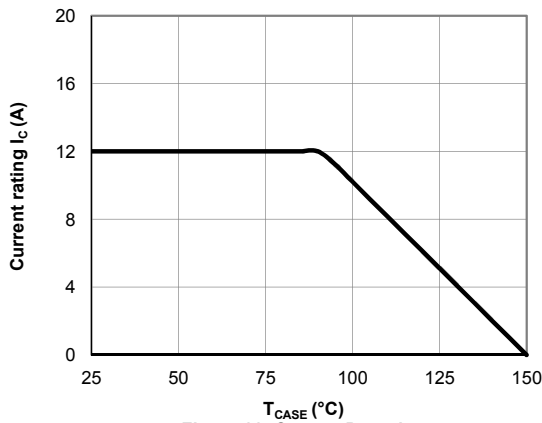


Figure 11: Current De-rating

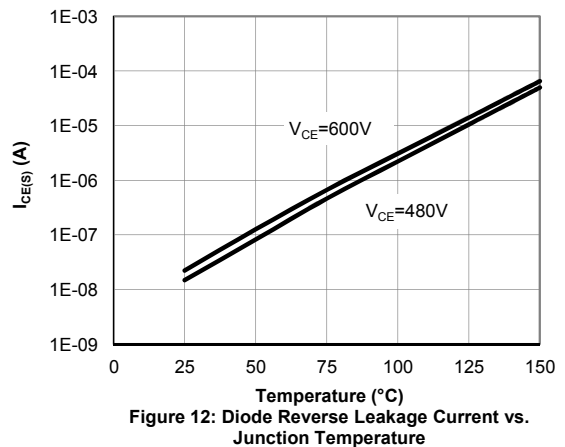
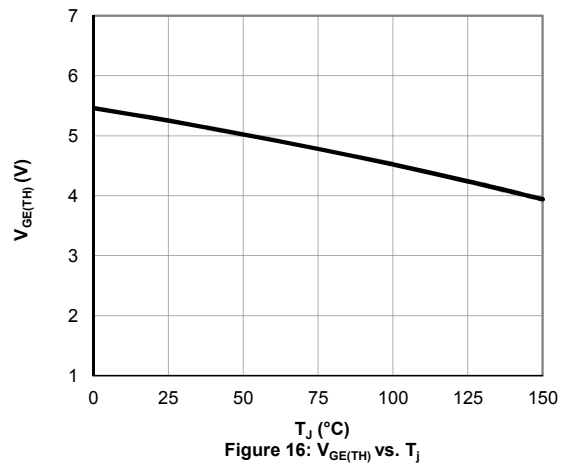
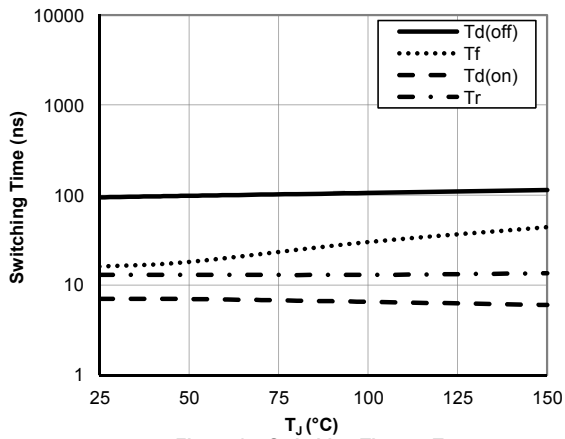
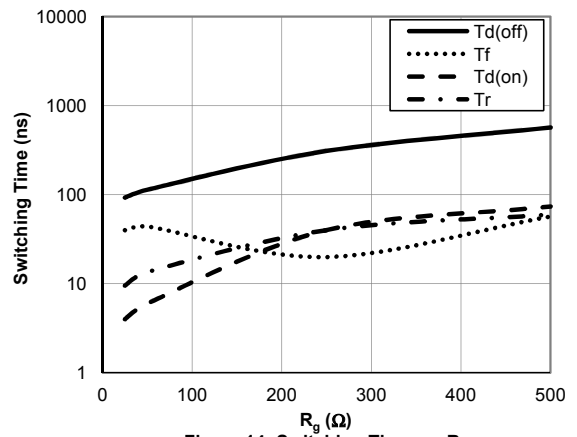
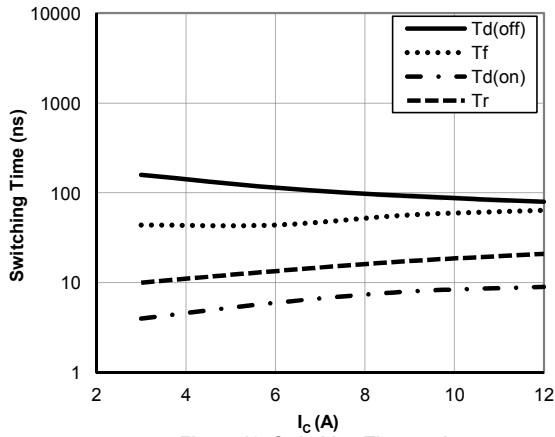
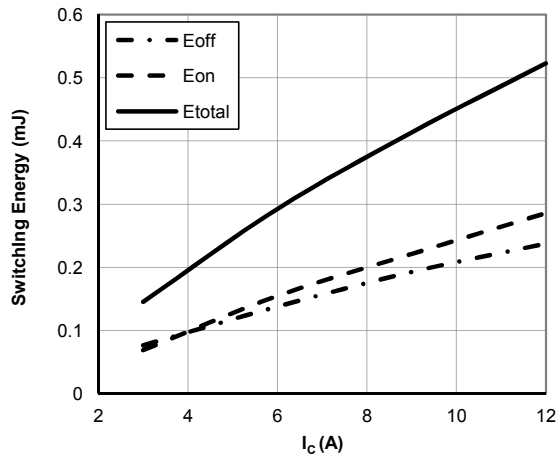


Figure 12: Diode Reverse Leakage Current vs. Junction Temperature

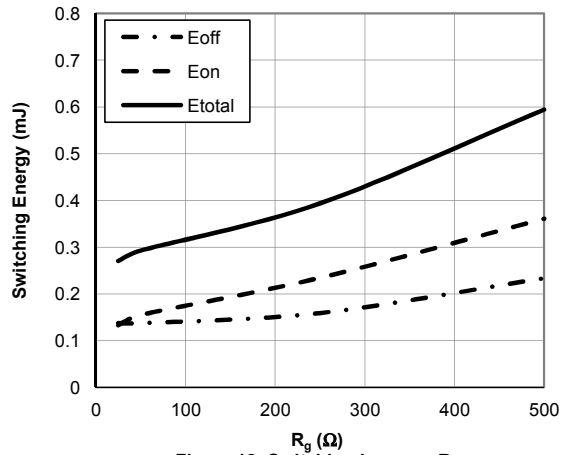
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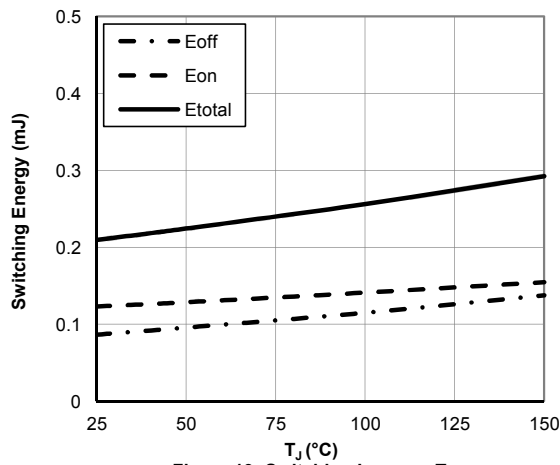
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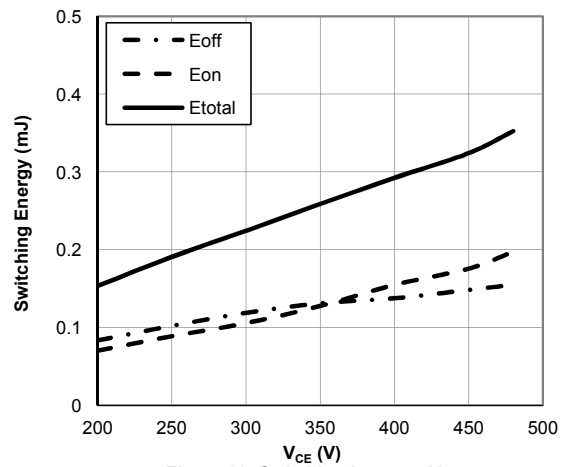
**Figure 17: Switching Loss vs.  $I_C$**   
( $T_J=150^\circ\text{C}$ ,  $V_{GE}=15\text{V}$ ,  $V_{CE}=400\text{V}$ ,  $R_g=50\Omega$ )



**Figure 18: Switching Loss vs.  $R_g$**   
( $T_J=150^\circ\text{C}$ ,  $V_{GE}=15\text{V}$ ,  $V_{CE}=400\text{V}$ ,  $I_C=6\text{A}$ )

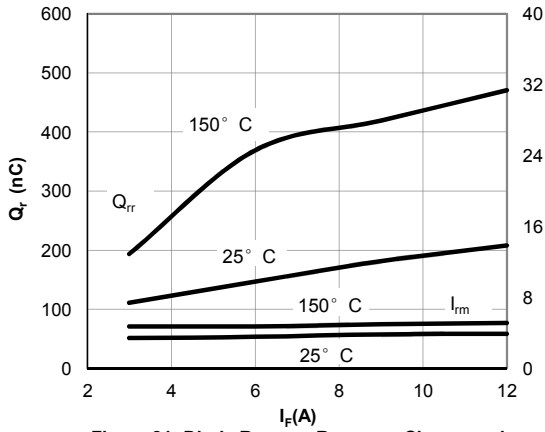


**Figure 19: Switching Loss vs.  $T_J$**   
( $V_{GE}=15\text{V}$ ,  $V_{CE}=400\text{V}$ ,  $I_C=6\text{A}$ ,  $R_g=50\Omega$ )

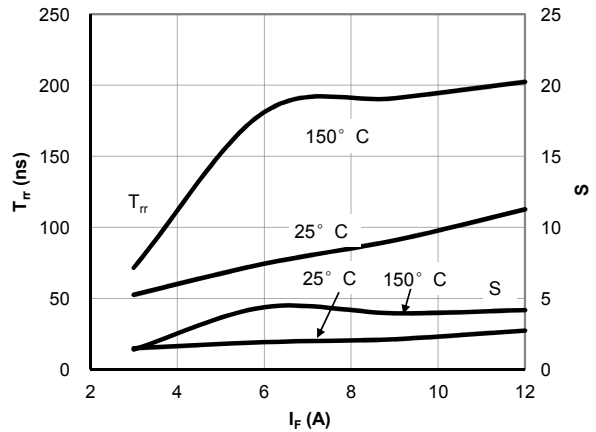


**Figure 20: Switching Loss vs.  $V_{CE}$**   
( $T_J=150^\circ\text{C}$ ,  $V_{GE}=15\text{V}$ ,  $I_C=6\text{A}$ ,  $R_g=50\Omega$ )

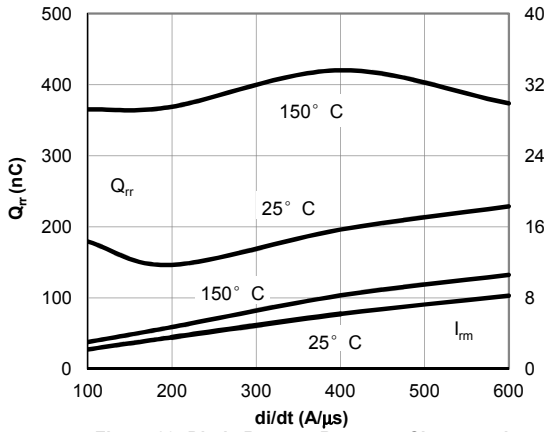
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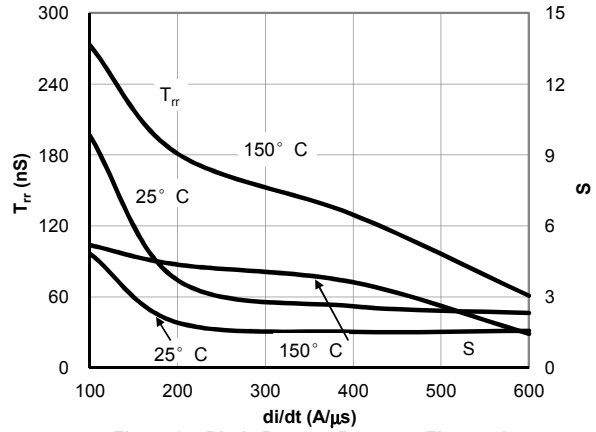
**Figure 21: Diode Reverse Recovery Charge and Peak Current vs. Conduction Current**  
( $V_{GE}=15V$ ,  $V_{CE}=400V$ ,  $di/dt=200A/\mu s$ )



**Figure 22: Diode Reverse Recovery Time and Softness Factor vs. Conduction Current**  
( $V_{GE}=15V$ ,  $V_{CE}=400V$ ,  $di/dt=200A/\mu s$ )

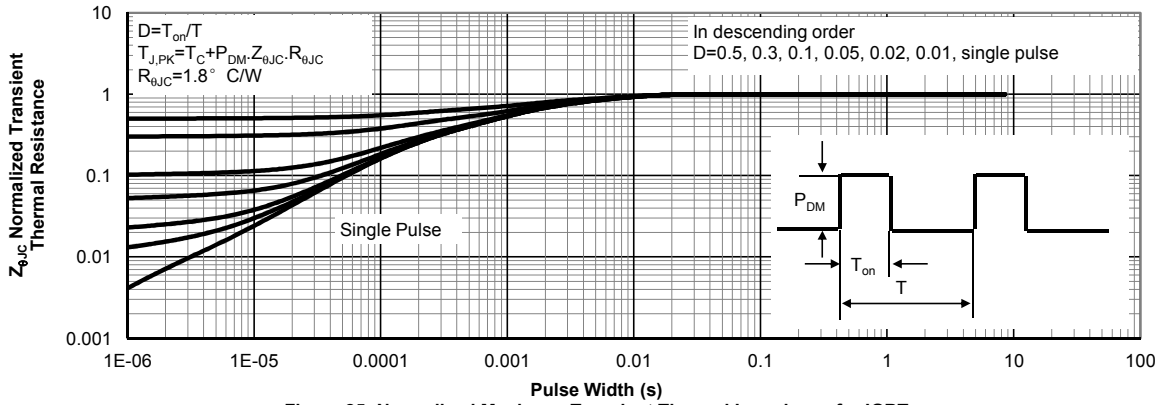


**Figure 23: Diode Reverse Recovery Charge and Peak Current vs. di/dt**  
( $V_{GE}=15V$ ,  $V_{CE}=400V$ ,  $I_F=6A$ )

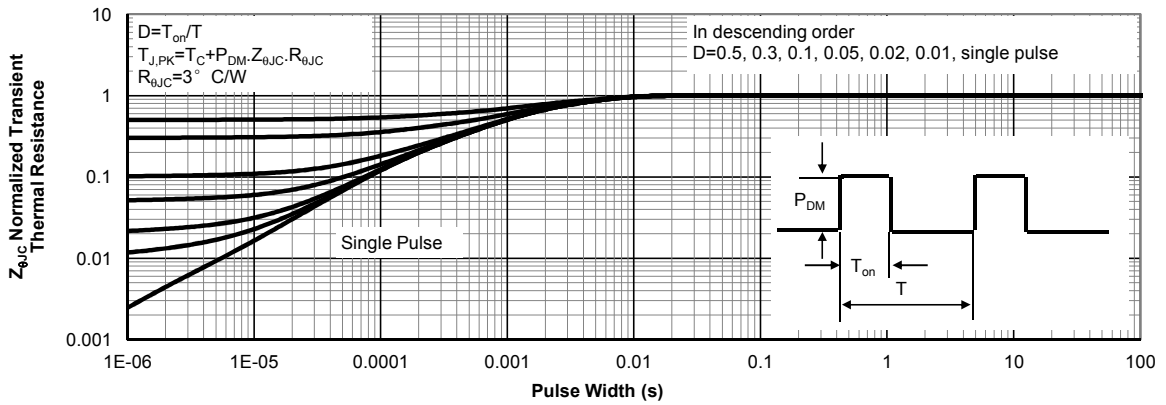


**Figure 24: Diode Reverse Recovery Time and Softness Factor vs. di/dt**  
( $V_{GE}=15V$ ,  $V_{CE}=400V$ ,  $I_F=6A$ )

**TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS**



**Figure 25: Normalized Maximum Transient Thermal Impedance for IGBT**



**Figure 26: Normalized Maximum Transient Thermal Impedance for Diode**



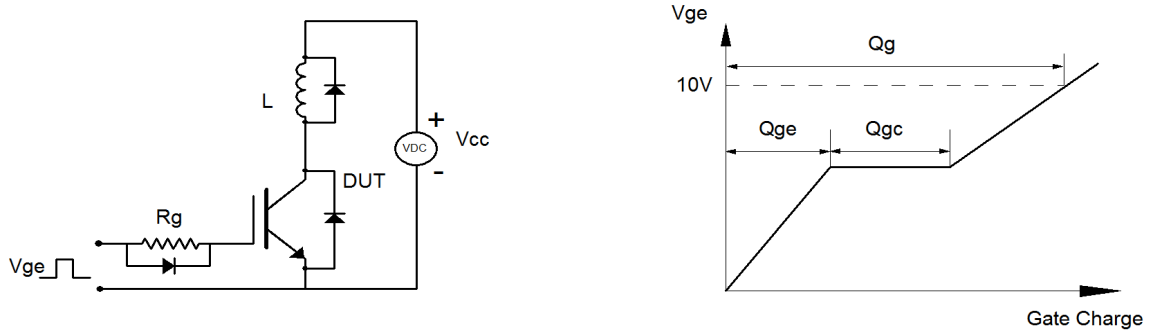


Figure A: Gate Charge Test Circuit & Waveforms

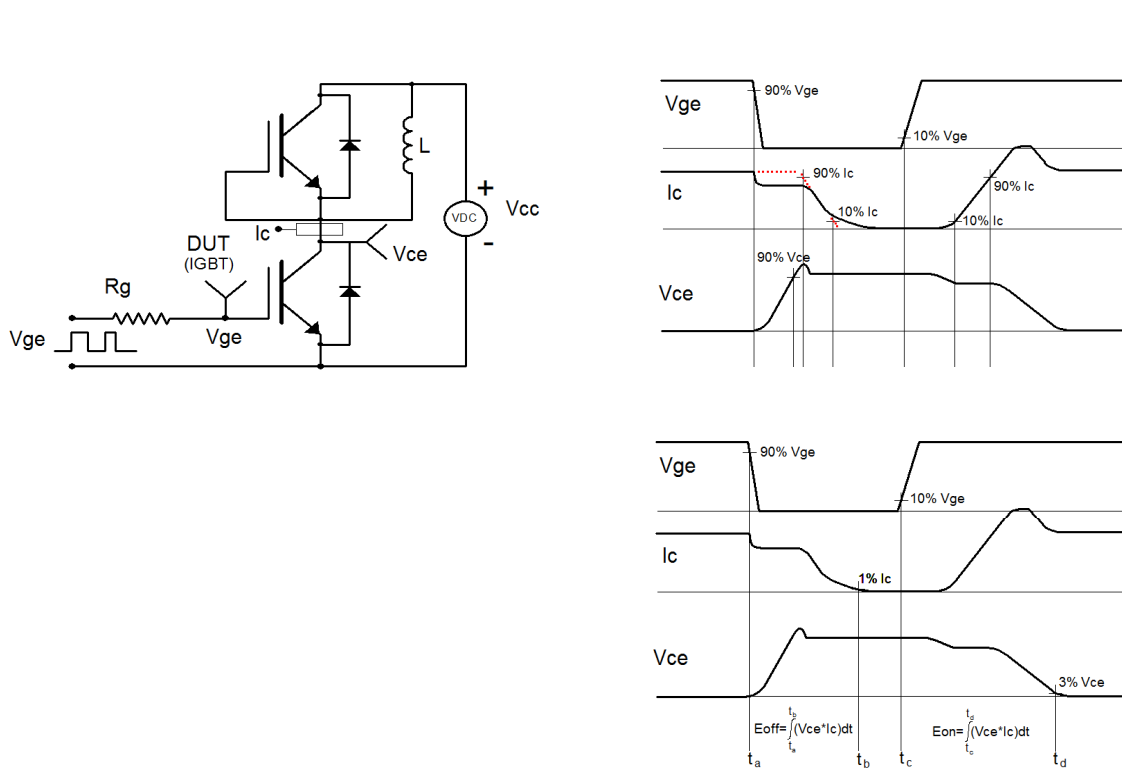


Figure B: Inductive Switching Test Circuit & Waveforms

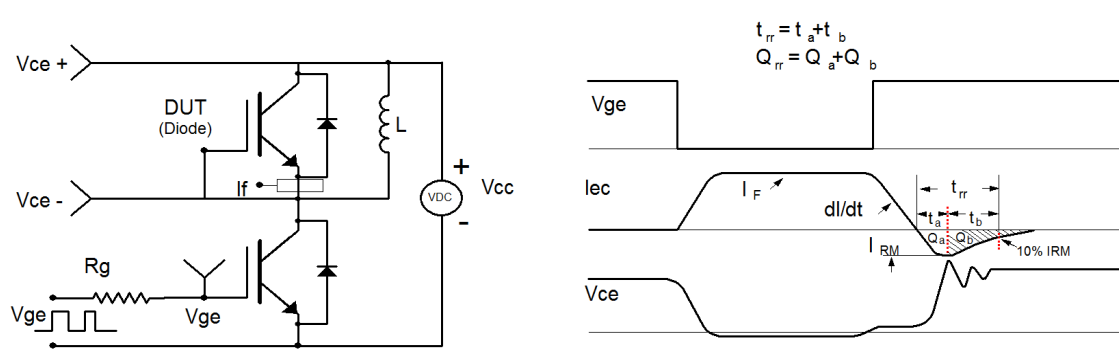


Figure C: Diode Recovery Test Circuit & Waveforms